

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ming-Tsung Lee</td> <td>03/19/2012</td> </tr> <tr> <td>Cheng-Hua Yang</td> <td>03/19/2012</td> </tr> <tr> <td>Wen-Fang Lee</td> <td>03/19/2012</td> </tr> <tr> <td>Chih-Chung Wang</td> <td>03/19/2012</td> </tr> <tr> <td>Te-Yuan Wu</td> <td>03/19/2012</td> </tr> </tbody> </table>		Name	Execution Date	Ming-Tsung Lee	03/19/2012	Cheng-Hua Yang	03/19/2012	Wen-Fang Lee	03/19/2012	Chih-Chung Wang	03/19/2012	Te-Yuan Wu	03/19/2012
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<table border="1"> <tr> <td>Name:</td> <td>UNITED MICROELECTRONICS CORP.</td> </tr> <tr> <td>Street Address:</td> <td>No.3, Li-Hsin Road 2, Science-Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsin-Chu City</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	UNITED MICROELECTRONICS CORP.	Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	City:	Hsin-Chu City	State/Country:	TAIWAN				
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CORRESPONDENCE DATA													
<p>Fax Number: (703)997-4517 Phone: 3027291562 Email: Patent.admin.uspto.cr@naipo.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506 Address Line 4: Merrifield, VIRGINIA 22116</p>													
ATTORNEY DOCKET NUMBER:	NAUP1472USA												
NAME OF SUBMITTER:	SIBYL YU												
Total Attachments: 4 source=1377227#page1.tif source=1377227#page2.tif source=1377227#page3.tif source=1377227#page4.tif													

CH \$40.00 13476019

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Ming-Tsung Lee Nationality: TW

Name: Cheng-Hua Yang Nationality: TW

Name: Wen-Fang Lee Nationality: TW

Name: Chih-Chung Wang Nationality: TW

Name: Te-Yuan Wu Nationality: TW

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: UNITED MICROELECTRONICS CORP.

Address: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"HIGH VOLTAGE METAL-OXIDE-SEMICONDUCTOR TRANSISTOR DEVICE AND
LAYOUT PATTERN THEREOF"

Which is found in :

- (a) + U.S. patent application executed on even date
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____
- (e) _____ International application no. _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this 7/19/2012 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Ming-Tsung Lee

Ming-Tsung Lee

Cheng-Hua Yang

Cheng-Hua Yang

Wen-Fang Lee

Wen-Fang Lee

Chih-Chung Wang

Chih-Chung Wang

Te-Yuan Wu

Te-Yuan Wu

PATENT

NPO#NAU-P1472-USA:0
CUST#UMCD-2012-0006

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DSC0-101U003044

PATENT

RECORDED: 05/21/2012

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